### **Epoxy Glass, Bakelite & Ceramics**

### For Heat Insulation Plates, see P.3780–3791

### **Characteristics of Epoxy Glass, Bakelite and Ceramics Characteristics of Epoxy Glass Plate**

Compared with paper based bakelite plates and fabric based bakelite plates, MISUMI's epoxy glass plates have high strength (mechanical strength), excellent heat resistance and moisture resistance. High Temperature Type has an excellent antistatic property.

### Characteristics of Bakelite Plate

MISUMI's Bakelite Plates are products which can be used as insulating plates for switch board, controller and breaker.

Paper Type is available in natural color and black. Strong Fabric Type is also available.

Bakelite Color (Natural Color) may vary depending on production lot, but does not affect quality.

### Characteristics of Ceramics

Alumina 96: Ceramics (Alumina 96/99) are excellent in abrasion resistance/insulation/heat resistance, and used for insulating/heat resisting parts in electronics, semiconductors and in other areas. In addition, it has equal or higher bending strength, compared with the common steel, and little elastic deformation.

Steatite: Ceramics Steatite are excellent in insulation as well as high frequency characteristic and are used as general insulation parts. It is a relatively low-cost material.

Machinable: Excellent machinability. Can be machined into complex forms. Precision finishing. Provides an excellent electric and thermal insulation.

### **Physical Property Values of Epoxy Glass and Bakelite**

					Part N	umber		
				Epoxy Gl	ass Plates	Bak	elite	
				Standard	High Temperature	Paper Type	Fabric Type P.3887 P.3114	
		Item	Plates	P.3096	P.3096	P.3098-3099		
		nom	Circular Plates	P.3114	_	P.3114		
			Unit	ЕРХА	EPXAR	BLA BLBA	BLSA	
Comp	Main Base M	aterial	—	Glass Fiber	Glass Fiber	Kraft Paper	Cotton	
Component	Main Materia	I	—	Epoxy Resin	Super-Insulated Epoxy	Phenol Resin	Phenol Resin	
<b>.</b>	Bending Strength		MPa {kgf/mm²}	310-450 {31-45}	499 (Vertical) / 553 (Horizontal) {51 (Horizontal) / 56 (Vertical)}	120–180 {12–18}	100–150 {10–15}	
Mechanical Properties	Compression	Vertical to Lamination	MPa {kgf/mm <sup>2</sup> }	470-539 {47-53.9}	_	250-320 {25-32}	200-250 {20-25}	
erti	Strength	Horizontal to Lamination	MPa {kgf/mm²}	294-392 {29.4-39.2}	_	170-210 {17-21}	100-150 {10-15}	
8 <u>8</u>	Izot Impact St	trength	J/cm	4.6 or More	_	0.2-0.5	0.5-0.7	
	Cleavage Stre	ength	kN	6.9–10.8	_	3.9-5.9	6.0-8.0	
Thermal Characteristics	Recommende Temperature	ed Operating (Note 1)	°C	Ambient Temperature: 155	Ambient Temperature: 260 (300°C Normal for 5 min.)	-50–100 (130°C 2 h Normal)	-50–100 (140°C 2 h Normal)	
herr	Reference - I	Destructive Temp. (Note 2)	°C	—	_	120	140	
nal	Expansion Co	efficient	°C-1	6.05 x 10 <sup>-5</sup>	6.0 x 10 <sup>-5</sup>	1.6x10-4	0.6 x 10 <sup>-4</sup>	
S	Thermal Cond	ductivity	W/m.k {cal/cm.sec.°C}	0.471 {1.125 x 10 <sup>-3</sup> }	0.38 {9.0 x 10 <sup>-4</sup> }	0.21 {0.5 x 10 <sup>-3</sup> }	0.38 {0.9 x 10 <sup>-3</sup> }	
₽	Dielectric Bre	akdown (Cross Layer)	kV/mm	20-30	_	20-28	12-20	
ectri	Edgewise Withstand Voltage		kV	—	—	12–18	8–15	
C	Volume	4 h / 150°C	Ω·cm	_	—	3.0 x 10 <sup>9</sup>	4.0 x 10 <sup>8</sup>	
hara	Resistivity	100 h / 25°C / 90% RH	Ω·cm		_	9.0 x 10 <sup>8</sup>	5.0 x 10 <sup>7</sup>	
cter	Surface Resistance			1013 - 1014	1.0 x 10 <sup>7</sup>	5.0 x 10 <sup>10</sup>	9.0 x 10 <sup>8</sup>	
Electric Characteristics	Insulation Ordinary Condition			1012 - 1014	_	1010 - 5 x 1011	5 x 109 - 10 <sup>10</sup>	
š	Resistance	After Boiling		5 x 1010 - 1013	_	5 x 107 - 10 <sup>8</sup>	108 - 10 <sup>9</sup>	
9	Arc Resistance		sec		_		_	
Others	Water Absorp	tion Ratio	%	0.02-0.03	0.02	0.5–1.3	1.6-1.8	
SI	Specific Grav	ity	_	1.75-1.9	1.95	1.4	1.4	

O Testing method conforms to JIS K6911. O Listed values are not guaranteed values but representative values.

(Note 1) "Recommended Operating Temperature" is the temperature when a long-term use does not reduce the quality rapidly.

(Note 2) "Destructive Temperature" is the temperature to start carbonization, collapse and melt.

### **Physical Property Values of Ceramics**

MiSUMi

		Part Number						
Item	Unit	CEA / PCEA	CEA	<b>CCES / PCCES</b>	CEM			
Material Name	—	Alumina 96 Al <sub>2</sub> 0 <sub>3</sub> 96%	Alumina 99 Al <sub>2</sub> 0 <sub>3</sub> 99.5%	Steatite Mg0 / SiO <sub>2</sub>	Machinable SiO <sub>2</sub> / MgO			
Apparent Density	g/cm <sup>3</sup>	3.7	3.9	2.6	2.5			
Water Absorption Ratio	%	0	0	0	0			
Bending Strength	Мра	350	450	160	94			
Thermal Conductivity	W/m·k	24	24	3	1.46			
Thermal Expansion	(20-500°C) x 10 <sup>-6</sup> /°C	7.2	8	7.8	9.4			
Coefficient	(20-800°C) x 10 <sup>-6</sup> /°C	7.9	—	8.2	12.6			
Melting Point	°C	2050	—	1557	1200			
Safety Operating Temperature	°C	1300	1300	1000	1000			
Insulation Resistance	kV/mm	>10	>10	>10	40			
Specific Volume Resistivity	Ω·cm	>1014	>1014	>1014	>1016			
Dielectric Constant	MHz	9	9	5.2	6.0			
Loss Coefficient	—	10.0 x 104	_	7.0 x 104	_			

O Alumina 99 (Al<sub>2</sub>O<sub>3</sub> 99.5%) is for CEA with plate thickness 2/2.5 or for plate thickness 1 with hole machining. O Listed values are not guaranteed values but representative values.

### Drilling Conditions of the Epoxy Glass

	Circular Cut	Milling	Drilling	
Tools	Carbide	Carbide	Carbide	
10015	(K-10)	(K-10)	(K-10)	
Cutting Speed V (m/min)	Large – Small Blades	Large – Small Blades	Large – Small Blades	
Cutung Speed v (m/mm)	45-200	100-300	120-350	
Develutions (r. n. m.)	Large – Small Blades	Large – Small Blades	Ø2 Drill 1000–1500	
Revolutions (r.p.m.)	50-1000	300-1000	Ø5 Drill 500-1000	
Cutting Depth (mm)	0.3-0.5	0.5-2.0	—	
Feed (mm/Rotation)	0.1-0.2	0.1-0.2	0.1-0.5	

\* For material colors or features, see P.3069

The above values are references only

### **Machinable Ceramics Drilling Conditions**

	Tools	High-Speed Steel	Carbide		
	Cutting Speed (m/min)	9–15	30–50		
Circular Cut	Feed (mm/Rotation)	0.05-0.13			
	Cutting Depth (mm)	0.5–6			
	Cutting Speed (m/min)		6–11		
Milling	Feed (mm/Rotation)	_	0.05		
	Cutting Depth (mm)	—	0.5–5		
Note	Revolution Frequency	Revolutions = Cutting Speed (m/min) /	per minute Diameter (mm) x 0.00314		

The above values are references only.

# **Resin Plates Characteristics II**

## **General-Purpose Engineered Plastic Plates**

### Characteristics of MC Nylon, Polyacetal, Ultra High-molecular-weight Polyethylene (UHMW), Fluororesin, PEEK, PPS, ABS, PBT and Free-cutting Resin

MISUMI's general-purpose Engineered Plastic plates have superior properties of lightweight, noise reduction and corrosion resistance. They can be used as a replacement for metal plates. Selectable from nine types of materials and several grades for various purposes.

MC Nylon: Having better abrasion resistance than that of polyacetal plates, MC nylon is generally used for slide guide plates. The product lineup is as follows: Sliding Grade with highlyimproved sliding performance; High Strength Grade with excellent strength; three types of Conductive Grade effective for antistatic purposes; and Weather Resistance Grade superior in strength deterioration.

Polyacetal: Widely used in wheels, rollers and gears, because of its excellent mechanical strength. MISUMI's polyacetal plates are offered in two colors: white and black. In addition, Sliding Grade with highly-improved sliding performance and Conductive Grade effective for antistatic purposes are also available. Ultra High-Molecular-Weight Polyethylene (UHMW): It excels in abrasion resistance and sliding properties, and is used for carrier rollers and guide rails. In addition to Standard Grade,

Conductive Grade effective for antistatic purposes is also available.

										Part Number				colors or teatur	03, 300 1.3003	
						MC Nylon							Polyacetal		Ultra High-molecular- weight Polyethylene	
Item				Standard	Sliding	High Strength	Weather Resistance	Conductivity CDR2	Conductivity CDR6	Conductivity CDR9	Standard	Electric Conductivity	Standard	Electric Conductivity		
		Testing Method	Plates	P.3100, 3118	P.3100	P.3100	P.3100	P.3100	P.3100, 3118	P.3100	P.3102	P.3102	P.3104	P.3114		
Iterni				Circular Plates	P.3114	P.3114	_	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114	P.3114	
				Unit	MCA MCAW MCAB	MCAS	MCAY	MCAPS	MCCA	MCDA MCDB	MCEA	PAA Paba Paab	PACA	UPA	UPACA	
		Normal		MPa	96	66	98	83	68	74	88	61	42	45	35	
	Tensile Strength	Temperature	D-638	{kgf/cm <sup>2</sup> }	{980}	{670}	{1000}	{850}	{700}	{760}	{900}	{620}	{430}	{460}	{360}	
	_	Continuous Use at High Temperature	D-030	MPa {kgf/cm <sup>2</sup> }	39 (120°C) {400 (120°C)}	-	-	—	_	-	-	29 (95°C) {300 (95°C)}	-	—	—	
z	Elongation		D-638	%	30	19	20	40	10	7	7	40	30	400	300	
lech	Bending Strength		D-790	MPa	110	92	152	110	117	117	132	89	49	25	25	
anica	bending Strength			{kgf/cm <sup>2</sup> }	{1120}	{940}	{1550}	{1120}	{1200}	{1200}	{1350}	{910}	{500}	{250}	{250}	
al Pr	Flexural Modulus		D-790	MPa	3530	2599	4609	_	4110	4020	4160	2589	1370	900	1103	
Mechanical Properties	Compression	Yield Point	D-695	MPa {kgf/cm <sup>2</sup> }	103 {1050}	_	_	101 {1030}	_	_	_	_	_	20 {200}	_	
	Strength	5% Deformation	5 000	MPa {kgf/cm <sup>2</sup> }	95 {970}	75 {760}	118 {1200}	93 {948}	98 {1000}	93 {950}	_	103 {1050}	44 {450}	_	25 {250}	
	Izot Impact Streng		D-256	J/m	50	39	50	50	35	35	35	74	77	Does Not Break	Does Not Break	
	Rockwell	R Scale	D-785		120	110	120	120	119	117	119	119	111	56	52	
	Hardness Temperature of	M Scale				_	Ambient	Ambient				78				
Thermal Characteristics	Temperature of Continuous Use			°C	-40–120	-40–120	Ambient Temp.: 150	Ambient Temp.: 120	Ambient Temp.: 120	Ambient Temp.: 120	Ambient Temp.: 150	-45-95	Ambient Temp.: 80	-10080	-100–80	
nal (	Melting Point		_	°C	222	221	222	222	215	215	218	165	_	136	_	
hara		0.45 Mpa	D-648	°C	215	215	215	215	215	215		158		80	108	
ıcter	Under Load	1.82Mpa	D-696	°C °C <sup>-1</sup>	200 9.0 x 10 <sup>-5</sup>	115 9.0 x 10 <sup>-5</sup>	200 6.5 x 10 <sup>-5</sup>	200 9.0 x 10 <sup>-5</sup>	200 8.0 x 10 <sup>-5</sup>	200 7.5 x 10 <sup>-5</sup>	200 8.6 x 10 <sup>-5</sup>	110 9.0 x 10 <sup>-5</sup>	106 16.7 x 10 <sup>-5</sup>	1.7 x 10 <sup>-4</sup>	55 19 x 10 <sup>-5</sup>	
stics	Thermal Conductiv	Linear Expansion Coefficient		W/m·k	0.233	0.233	0.5 × 10	0.23	0.512	0.709	0.0 x 10	0.233	10.7 × 10	0.42		
<i>"</i>	Surface Resistivity	ity	D-177 D-257	_		_	_			_	_	_	_	10 <sup>13</sup>	_	
hara	Specific Volume Re	esistivity	D-257	Ω·cm	4.2 x 10 <sup>15</sup>	_	_	_	10 <sup>2</sup> -10 <sup>4</sup>	10 <sup>4</sup> -10 <sup>6</sup>	10 <sup>6</sup> -10 <sup>8</sup>	>1014	10 <sup>10</sup> -10 <sup>12</sup>	10 <sup>17</sup>	10 <sup>4</sup>	
lectri	Insulation Breakdo	wn Voltage	D-149	kV/mm	20	_	—	18	—	_	—	20	—	68	_	
Electric Characteristics	Dielectric Constant	10 <sup>6</sup> Hz	D-150		3.7	_		3.7				3.7		2.3		
	Dissipation Factor	10 <sup>6</sup> Hz	D-150		0.02	1.11	1.27	0.02	1.2	1.23	 1.19	0.007	1.33	0.94	0.95	
	Specific Gravity	In Water, Level	D-792 D-570	%	6		-	6.0	-	- 1.23	-	0.7	-	<0.01		
	Water Absorption Ratio	In Water, 24hs	D-570	%	0.8	0.5	_	0.8	_	_	_	0.22	2	0.8	_	
	Abrasion Resistand	ce	_	—	Good	Excellent	Good	Excellent	Acceptable	Acceptable	Good	Acceptable	Good	Excellent	Good	
	Sliding Properties		—	—	Good	Excellent	Good	Good	Good	Good	Good	Good	Good	Excellent	Good	
		Dynamic Friction Coefficient				0.05-0.1							0.18	0.07-0.22	0.17-0.19	
		Dimension Stability			Acceptable Good	Acceptable Good	Acceptable Good	Acceptable	Acceptable Good	Acceptable Good	Acceptable Good	Good Good	Acceptable Good	Acceptable Excellent	Acceptable Excellent	
Others	Impact Resistance Flame Resistance		 [UL94]		(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)	(HB or Equivalent)					
	Food Sanitation Laws		_	_	Suitable*	Suitable*	Suitable*	Suitable (After Boiling)	Suitable*	Suitable*	Suitable*	Suitable	Suitable	Suitable	Suitable	
	FDA Registration	-DA Registration		_	_	_	-		—	_	-	_	_	Finished	_	
		Oil	_	—	Good	Good	Good	Good	Good	Good	Good	Good	Good	Good	Good	
	Chemical	Acid	_	_	Poor	Poor	Poor	Poor	Poor	Poor	Poor	Acceptable / Poor	Acceptable / Poor	Excellent	Good	
	Resistance	Alkali	_	_	Good / Acceptable	Good / Acceptable	Good / Acceptable	Good	Good	Excellent	Good					
		Organic Solvent	—	_	Good	Good	Good	Good	Good	Good	Good	Good	Good	Excellent	Good	

\*Comply with Food Sanitation Laws in Japan (MC Nylon, Standard, Sliding Grade and High Strength Grade: After boiling for 1.5 hours; Conductive CDR2, CDR6 and CDR9: After boiling for 2 hours) O Listed values are not guaranteed values but representative values.

# Fransparent Resin / Glass / Mir Engineered Plastic Plates

^For material	colors or	teatures,	see P.3069